



US 20210098921A1

(19) **United States**(12) **Patent Application Publication**
Mahmoud et al.(10) **Pub. No.: US 2021/0098921 A1**(43) **Pub. Date: Apr. 1, 2021**(54) **LOW-IMPEDANCE, LOW-HARMONIC
SPRING CLIPS****Publication Classification**(51) **Int. Cl.****H01R 13/24** (2006.01)**H01Q 1/52** (2006.01)**H01R 13/426** (2006.01)**H01R 24/78** (2006.01)(52) **U.S. Cl.**CPC **H01R 13/2421** (2013.01); **H01R 24/78**
(2013.01); **H01R 13/426** (2013.01); **H01Q**
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26, 2019.

(57)

ABSTRACT

Spring clips that provide a reliable, low-impedance, low-harmonic path between various conductive enclosure components of electronic devices. These spring clips can include a low-impedance connection on each of two ends, where each end physically and electrically connects to an enclosure component of an electronic device. This can reduce an impedance between enclosure components and reduce the amplitude and harmonics of signals coupled onto them from a nearby antenna or other waveguide.

